



SLOVENSKI STANDARD
SIST EN IEC 62769-103-4:2020

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Nadomešča:

SIST EN 62769-103-4:2015

Vključitev procesne naprave (FDI) - 103-4. del: Profili - PROFINET (IEC 62769-103-4:2020)

Field Device Integration (FDI) - Part 103-4: Profiles - PROFINET (IEC 62769-103-4:2020)

Feldgeräteintegration (FDI) - Teil 103-4: Profile - PROFINET (IEC 62769-103-4:2020)

Intégration des appareils de terrain (FDI) - Partie 103-4: Profils - PROFINET (IEC 62769-103-4:2020)

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35.240.50	Uporabniške rešitve IT v industriji	IT applications in industry

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EUROPEAN STANDARD

EN IEC 62769-103-4

NORME EUROPÉENNE

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June 2020

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Supersedes EN 62769-103-4:2015 and all of its
amendments and corrigenda (if any)

English Version

**Field device integration (FDI) - Part 103-4: Profiles - PROFINET
(IEC 62769-103-4:2020)**Intégration des appareils de terrain (FDI) - Partie 103-4:
Profils - PROFINET
(IEC 62769-103-4:2020)Feldgeräteintegration (FDI) - Teil 103-4: Profile -
PROFINET
(IEC 62769-103-4:2020)

This European Standard was approved by CENELEC on 2020-06-02. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the CEN-CENELEC Management Centre or to any CENELEC member.

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European Committee for Electrotechnical Standardization
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Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

EN IEC 62769-103-4:2020 (E)**European foreword**

The text of document 65E/623/CDV, future edition 2 of IEC 62769-103-4, prepared by SC 65E "Devices and integration in enterprise systems" of IEC/TC 65 "Industrial-process measurement, control and automation" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 62769-103-4:2020.

The following dates are fixed:

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2021-03-02
- latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2023-06-02

This document supersedes EN 62769-103-4:2015 and all of its amendments and corrigenda (if any).

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The text of the International Standard IEC 62769-103-4:2020 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following notes have to be added for the standards indicated:

IEC 61784-1	NOTE	Harmonized as EN IEC 61784-1
IEC 61804-4	NOTE	Harmonized as EN 61804-4

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 61158-5-10	-	Industrial communication networks - Fieldbus specifications - Part 5-10: Application layer service definition - Type 10 elements	EN IEC 61158-5-10	-
IEC 61784-2	-	Industrial communication networks - Profiles - Part 2: Additional fieldbus profiles for real-time networks based on ISO/IEC/IEEE 8802-3	EN IEC 61784-2	-
IEC 61804 series		Function blocks (FB) for process control and electronic device description language (EDDL)	EN IEC 61804 series	series
IEC 62541-100	2015	OPC Unified Architecture - Part 100: Device Interface	EN 62541-100	2015
IEC 62769-2	-	Field Device Integration (FDI) - Part 2: FDI Client	-	-
IEC 62769-4	-	Field Device Integration (FDI) - Part 4: FDI Packages	-	-
IEC 62769-5	-	Field Device Integration (FDI) - Part 5: FDI Information Model	-	-
IEC 62769-6	-	Field Device Integration (FDI) - Part 6: FDI Technology Mapping	-	-
IEC 62769-7	-	Field Device Integration (FDI) - Part 7: FDI Communication Devices	-	-
PI Order No: 2.122	2008	Specification for PROFIBUS - Device Description and Device Integration - Volume 1: GSD, V5.1, July 2008: GSD	-	-
PI Order No.: 2.352	2014	GSDML Specification for PROFINET IO	-	-

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INTERNATIONAL STANDARD

NORME INTERNATIONALE



Field device integration (FDI) –
Part 103-4: Profiles – PROFINET

STANDARD PREVIEW
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Intégration des appareils de terrain (FDI) –
Partie 103-4: Profils – PROFINET

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CONTENTS

FOREWORD	4
1 Scope	6
2 Normative references	6
3 Terms, definitions, abbreviated terms and conventions	7
3.1 Terms and definitions	7
3.2 Abbreviated terms	7
3.3 Conventions	7
3.3.1 EDDL syntax	7
3.3.2 XML syntax	7
3.3.3 Capitalizations	7
4 Profile for PROFINET	8
4.1 General	8
4.2 Catalog profile	8
4.2.1 Protocol support file	8
4.2.2 CommunicationProfile definition	9
4.2.3 Profile device	9
4.2.4 Protocol version information	9
4.3 Associating a Package with a device	10
4.3.1 Device type identification mapping	10
4.3.2 Device type revision mapping	11
4.4 Information Model mapping	12
4.4.1 ProtocolType definition	12
4.4.2 DeviceType mapping	12
4.4.3 FunctionalGroup identification definition	13
4.5 Topology elements	13
4.5.1 ConnectionPoint definition	13
4.5.2 Communication Device definition	15
4.5.3 Communication service provider definition	16
4.5.4 Network definition	17
4.6 Methods	17
4.6.1 Methods for FDI Communication Servers	17
4.6.2 Methods for Gateways	21
Annex A (normative) Topology scan schema	28
A.1 General	28
A.2 Network	28
A.3 ProfinetNetworkT	28
A.4 ProfinetConnectionPointT	28
A.5 ProfinetIdentificationT	29
A.6 MACT	30
A.7 IPv4T	30
A.8 IPv6T	30
A.9 DNSNameT	30
A.10 Hex4DigitT	30
Annex B (normative) Transfer service parameters	31
B.1 General	31
B.2 sendData	31

B.3	receiveData	31
B.4	TransferSendDataT.....	31
B.5	TransferResultDataT.....	32
B.6	OperationT.....	32
	Bibliography.....	33
	Figure 1 – Version mapping problem.....	11
	Table 1 – ProtocolSupportFile for FDI Device Packages	8
	Table 2 – ProtocolSupportFile for FDI Communication Packages	9
	Table 3 – Catalog values for profile devices.....	9
	Table 4 – Version mapping examples.....	10
	Table 5 – Device identification information mapping.....	11
	Table 6 – Protocol type Profinet_IO	12
	Table 7 – DeviceType Property mapping.....	13
	Table 8 – PROFINET identification type definition.....	13
	Table 9 – ConnectionPoint type for Profinet_IO	14
	Table 10 – Method Connect arguments.....	18
	Table 11 – Method Disconnect arguments	18
	Table 12 – Method Transfer arguments.....	19
	Table 13 – Method SetAddress arguments.....	20
	Table 14 – Method Connect arguments.....	22
	Table 15 – Method Transfer arguments.....	23
	Table 16 – Method SetAddress arguments.....	25
	Table A.1 – Elements of ProfinetNetworkT	28
	Table A.2 – Attributes of ProfinetConnectionPointT.....	29
	Table A.3 – Elements of ProfinetConnectionPointT	29
	Table A.4 – Attributes of ProfinetIdentificationT	29
	Table B.1 – Attributes of TransferSendDataT.....	32
	Table B.2 – Attributes of TransferResultDataT.....	32

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FIELD DEVICE INTEGRATION (FDI) –

Part 103-4: Profiles – PROFINET

FOREWORD

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International Standard IEC 62769-103-4 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

This second edition cancels and replaces the first edition published in 2015. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) support for generic protocol extension for faster adoption of other technologies;
- b) support for Package Developers to build EDDs targeted for today’s EDD bases system under a single development tool.

The text of this International Standard is based on the following documents:

CDV	Report on voting
65E/623/CDV	65E/686A/RVC 65E/686/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
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FIELD DEVICE INTEGRATION (FDI) –

Part 103-4: Profiles – PROFINET

1 Scope

This part of IEC 62769 specifies an FDI profile of IEC 62769 for IEC 61784-2_CP 3/4, IEC 61784-2_CP3/5 and IEC 61784-2_CP3/6 (PROFINET¹).

2 Normative references

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IEC 61158-5-10, *Industrial communication networks - Fieldbus specifications - Part 5-10: Application layer service definition - Type 10 elements*

IEC 61784-2, *Industrial communication networks - Profiles - Part 2: Additional fieldbus profiles for real-time networks based on ISO/IEC/IEEE 8802-3*

IEC 61804 (all parts), *Function blocks (FB) for process control and Electronic Device Description Language (EDDL)*

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IEC 62541-100:2015, *OPC Unified Architecture - Part 100: Device Interface*

IEC 62769-2, *Field Device Integration (FDI) - Part 2: FDI Client*

IEC 62769-4, *Field Device Integration (FDI) - Part 4: FDI Packages*

IEC 62769-5, *Field Device Integration (FDI) - Part 5: FDI Information Model*

IEC 62769-6, *Field Device Integration (FDI) - Part 6: FDI Technology Mapping*

IEC 62769-7, *Field Device Integration (FDI) - Part 7: FDI Communication Devices*

PI Order No.: 2.122:2008, *Specification for PROFIBUS – Device Description and Device Integration – Volume 1: GSD, V5.1, July 2008: GSD*; available at <www.PROFIBUS.com>

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